

Technical Data Sheet

Product Description

DuPont 6160 is a solderable conductor composition for high volume hybrid microcircuits and resistor networks. DuPont 6160 has been developed as a low cost alternative to palladium silver and platinum silver conductors. DuPont 6160 is a mixed bonded silver conductor with performance equal or superior to that of many platinum silver composition.

Product Benefits

- Very low resistivity of $<2 \text{ m}\Omega/\text{sq}$
- Good solder leach resistance in 62Sn/36Pb/2Ag solder
- SPRINT® vehicle, permitting long production runs with squeegee speeds up to 30 cm/sec

Processing

Printing

Print with 200-325 mesh stainless steel screen. DuPont 6160 may be printed at squeegee speeds of 5-30 cm/s (2-12.5 in/s) and at a rate of one substrate per second. At high printing speeds optimum results are obtained with a sharp squeegee, a 30° or 45° angle of attack, a force of 10-20 N (2-4.5 lbs of squeegee pressure).

Drying

Allow prints to level 5-10 minutes at room temperature. Then dry 10-15 minutes at 150°C.

Firing

Fire with a 30-60 minute cycle to a peak temperature of 850°C for 5-10 minutes.

Typical Physical Properties

Test	Properties
Line Resolution (µm)	150 - 200
	(6-8 mil)
Fired Thickness (µm)	16 - 20
	(0.6 - 0.7 mil)
Resistivity (mΩ/sq)	< 2
Soldering	Excellent
Initial Acceptance ²	
62Sn/36Pb/2Ag	
Resistance to Leaching ³ 62Sn/36Pb/2Ag	3 cycles
Adhesion on 96% Alumina	≥ 22
Initial (N)	
Aged (150°C, 500 hrs) (N)	> 20
	Reliable thermosonic gold wire bonds Initial and aged (1000 hr., 150°C) pull strengths of 9 grams. No bond lifts were observed.
Aluminum Wire	Not recommended
Composition Properties	
Viscosity (Pa.s) (Brookfield RVT, UC&SP and #14 spindle, 10 rpm, 25°C)	85-115
Coverage ¹,(cm²/g/mil)	50-60
	(7.9-9.5 in²/g)
Thinner	DuPont 4553
1 Reserved on 200 mach stainless steel screen with 4	Our wire diameter and 17 F um emulaion

Based on 200-mesh stainless steel screen with 40µm wire diameter and 17.5 µm emulsion hickness

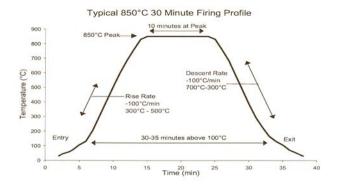
Excellent characterized as complete wetting with smooth solder film after 5-second dip at 220°C using mildly-activated flux (Alpha 611).

Cycle consists of dip in mildly-activated flux (Alpha 611), 10-second dip in solder at 220°C and

vashing off flux residue. 25 µm (1 mil) gold wire thermosonic bonded.

This table shows anticipated typical physical properties for DuPont 6160 based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

Typical 30 minutes fire profile



Storage and Shelf Life

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

Safety and Handling

For Safety and Handling information pertaining to this product, read the Material Safety Data Sheet (MSDS).

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